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Hybrid integrated photonics using bulk acoustic resonators

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Integrated photonic devices based on Si_3N_4 waveguides allow for the exploitation of nonlinear frequency conversion, exhibit low propagation loss, and have led to advances in compact atomic clocks, ultrafast ranging, and spectroscopy. Yet, the lack of Pockels effect presents a major challenge to achieve high-speed modulation of Si_3N_4 . Here, microwave-frequency acousto-optic modulation is realized by exciting high-overtone bulk acoustic wave resonances (HBAR) in the photonic stack. Although HBAR is ubiquitously used in modern communication and superconducting circuits, this is the first time it has been incorporated on a photonic integrated chip. The tight vertical acoustic confinement releases the lateral design of freedom, and enables negligible cross-talk and preserving low optical loss. This hybrid HBAR nanophotonic platform can find immediate applications in topological photonics with synthetic dimensions, compact opto-electronic oscillators, and microwave-to-optical converters. As an application, a Si_3N_4 -based optical isolator is demonstrated by spatiotemporal modulation, with over 17 dB isolation achieved.





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ntegrated photonics has drawn increasing attention in recent years. Although within the last decade, silicon photonics has transitioned from laboratory-based research into commercial products used in data centers, major efforts are still underway with regards to silicon nitride (Si_3N_4) photonic devices¹. The Si_3N_4 platform has attracted intense efforts due to its wide transparency window from the visible to mid-infrared, ultralow linear losses¹, absence of two-photon absorption in the telecommunication band, large Kerr nonlinearity $\chi^{(3)}$, small Brillouin gain², and flexibility for waveguide geometric dispersion engineering³. Silicon nitride has been a popular material of choice for dissipative Kerr soliton microcomb generation⁴. In addition, supercontinuum generation³, optical filters⁵, gyroscopes⁶, and coherent telecommunication⁷ have been demonstrated using Si₃N₄. Recent advances of Si₃N₄-based soliton microcombs have included octave-spanning comb spectra^{8,9}, ultralow initiation power¹⁰⁻¹², and microcomb repetition rates in the microwave domain¹³. Reliable and fast resonance tuning of Si₃N₄ microresonators is an important asset and requirement for multiple applications in integrated photonics. For example, highbandwidth tuning allows microcomb repetition rate stabilization¹⁴, or resonance tuning for filters⁵. Likewise, recently emerged platforms such as spatiotemporal-modulation-based optical nonreciprocity¹⁵ and topological optical bandstructures^{16,17} require GHz-rate modulation within optical microresonators, which poses stringent requirements on the cross-talk and size. However, due to the inversion symmetry, and thus the lack of $\chi^{(2)}$ nonlinearity, it is challenging to electrically modulate the refractive index of Si₃N₄. Traditionally, the thermo-optical effect is employed to fulfill the tuning requirement^{18,19}. However, thermal tuning presents low tuning speed (~1 kHz), high power consumption (~10 mW), and large cross-talk. These drawbacks make it incompatible with large-scale integration and cryogenic applications²⁰. Although hybrid integration with various electrooptical materials, e.g., graphene²¹, lead zirconate titanate (PZT)²², lithium niobate $(LiNbO_3)^{23}$, and monolayer WS_2^{24} , has made significant progress, there are still remaining challenges related to Complementary Metal Oxide Semiconductor (CMOS) compatibility, fabrication complexity, optical loss, and dispersion engineering. To fully utilize the maturity and advantages of Si₃N₄ photonics, new tuning mechanisms that retain the original optical properties (e.g., waveguide low-loss and dispersion) are needed.

The stress-optical effect, discovered over a 100 years ago, has recently gained attention for its role in the modulation of Si₃N₄ waveguides and microring resonators, both theoretically^{25,26} and experimentally^{27,28}, thanks to the advances in Micro-Electro-Mechanical Systems²⁹. In this work, by integrating aluminium nitride (AlN) piezoelectric actuators on top of Si₃N₄ photonic devices, we demonstrate, to the best of our knowledge, the first acousto-optic modulation (AOM) of Si₃N₄ microring resonators using high-overtone bulk acoustic wave resonances (HBARs)³⁰. Sub-micrometer wavelength acoustic waves are excited by macroscopic actuators, which transmit vertically into the substrate and perpendicular to optical paths (see Fig. 1a). Trapped inside a Fabry-Pérot-like acoustic cavity that is formed by the top and bottom surfaces of the entire substrate, a rich family of acoustic resonant modes is efficiently excited at the microwave frequencies up to 6 GHz. The coupling between vertical acoustic waves and in-plane optical circuits makes it possible for independent optimization of the actuator and optical components. Specifically, Si₃N₄ waveguide can be buried deeply inside the oxide cladding for preserving the low optical losses. The high lateral acoustic mode confinement further enables low cross-talk and compact integration. These features are in stark contrast with conventional surface acoustic wave (SAW) AOM^{26,31}, which requires an interdigital transducer (IDT) with sub-micrometer electrode fingers,

coplanar integration of IDT and optical waveguides, and perfect termination of acoustic waves to reduce cross-talk.

The same structure platform is also capable of linear bidirectional tuning of Si_3N_4 microring resonators (-0.2 pm V⁻¹), which shows a high power efficiency of 5 nW pm^{-1} resonant wavelength tuning (in stark contrast to thermal tuning on the order of 1 mW pm^{-118}). Although similar optical resonance tuning can be achieved via PZT with 26 pm V^{-1} tuning ability²⁸, AlN has the advantages of high actuation linearity, no hysteresis, high power handling (breakdown field > 150 V μ m⁻¹), and low current leakage, which are more important for microcomb tuning and stabilization. For example, resonance tuning of 10 pm (corresponding to frequency excursion of GHz) is sufficient to control the soliton state¹⁹, which is within the reach of our ability. However, once the soliton state is accessed, the resonance needs to be anchored by the resonant actuator. In this case, the power consumption is the most important figure of merit to consider. The current demonstration of PZT tuning shows power consumption of 1.2 μ W pm⁻¹ due to its large leaky current²⁸, which is two orders of magnitude larger. Moreover, the large losstangent of PZT makes it resistive at microwave frequencies, which prevents GHz modulation.

Here we show the GHz AOM of Si₃N₄ microring resonator by piezoelectrically exciting a family of the fundamental HBAR modes with free spectral range (FSR) of 17.5 MHz. The cross-talk between adjacent actuators is kept around -60 dB over wide frequencies. The tuning speed is fully explored, demonstrating sub-nanosecond actuation capability, which is mainly limited by intrinsic acoustic resonances. This simple but multi-functional stress-optical platform demonstrated in this work would enable advanced applications in Si₃N₄ photonic platform³², such as the repetition rate stabilization of soliton microcombs via injection locking³³, on-chip optomechanical frequency comb generation³⁴, and comb-assisted microwave photonic filters³⁵. As an application demonstration, we show in the last section the realization of a fully integrated, electrically driven Si₃N₄ microring isolator via spatiotemporal modulation. A 17 dB isolation is achieved with 1 GHz bandwidth.

Results

Device design. The c-axis oriented polycrystalline AlN, with a piezoelectric coefficient $e_{33} \sim 1.55$ C m^{-2 36}, is utilized to form the piezoelectric actuator, which will be deformed and generate stress around the Si₃N₄ waveguide when a vertical electric field is applied. As shown in Fig. 1a, a disk-shaped actuator is placed directly on top of the Si₃N₄ microring resonator such that their edges are congrunt. When the actuator is driven harmonically, vibration of the AlN disk launches an acoustic wave vertically into the substrate (Fig. 1a). As the bottom surface of the substrate is smooth and flat, the acoustic wave is reflected and subsequently bounces back and forth between the top and bottom surfaces. Working as an acoustic Fabry-Pérot cavity, the counterpropagating acoustic waves will constructively interfere when the cavity length is an integer number of the acoustic wavelength, with acoustic energy trapped inside the cavity. These bulk acoustic standing waves further enhance the stress field around the Si₃N₄ waveguides and modulate the refractive index through stress-optical effect²⁵.

The device cross-section is illustrated in Fig. 1b. To apply the vertical electric field, an AlN film of 1 μ m thickness is sandwiched between top Al (100 nm thickness) and bottom Mo (100 nm thickness) metal layers. The Si₃N₄ waveguides are fabricated using a subtractive process³⁷ and have a height of 0.8 μ m and width of 1.8 μ m. The waveguides are fully buried in SiO₂ cladding of 5.4 μ m thickness (2.4 μ m SiO₂ from the Mo layer to prevent metal



Fig. 1 Hybrid nanophotonic high-overtone bulk acoustic resonator (HBAR) platform. a 3D schematic illustrating excitation of bulk acoustic waves via a macroscopic piezoelectric actuator, which transmit vertically into the stack and form acoustic standing waves inside the acoustic Fabry-Pérot cavity. The resonance-enhanced mechanical stress changes the waveguide's refractive index via the stress-optical effect and thereby modulates the output optical intensity. **b** Cross-section of the device along the black dashed line in **c**, with critical dimensions labeled. The AIN piezoelectric actuator is placed directly on top of the Si₃N₄ microring resonator which is embedded in 5.4 μm of SiO₂ cladding. **c** Optical microscope image of the fabricated device.

absorption). The entire device sits on a 230 μ m-thick Si substrate. The radius of the microring resonator is 118 μ m, and is placed 3 μ m within the edge of disk actuator. The final fabricated device is shown in Fig. 1c (see Methods for more fabrication details). The area around the waveguide-to-microring coupling region is opened to prevent any actuation-induced perturbation of light coupling between bus waveguide and microring resonator.

High overtone bulk acoustic wave resonances. The electromechanical reflection parameter S₁₁ is first measured experimentally using port 1 of a network analyzer (Fig. 2g), which characterizes the energy conversion from electrical to mechanical vibration as a dip. As shown in Fig. 2a, a series of resonance dips is evenly distributed over multiple octaves in the microwave regime. A zoom-in of the spectrum is illustrated in Fig. 2d, highlighting the resonance shape, linewidth (~3 MHz), and acoustic FSR of around 17.5 MHz. The narrow linewidth demonstrates high mechanical Q (~1000), which is mainly limited by the intrinsic acoustic loss in the substrate and scattering at material interfaces. Meanwhile, the envelope of these sharp resonances varies slowly and smoothly with a period of ~490 MHz. This is caused by the resonance inside the 5.4 µm SiO₂ cladding layer, which stems from acoustic wave reflections at the Si-SiO₂ interface due to an acoustic impedance mismatch. The position of SiO₂ resonance is located at the node of the envelope, whereas anti-resonance is located at the anti-node. Intuitively speaking, at the anti-resonance of the SiO₂ layer, it works effectively as an acoustic anti-reflection coating such that more acoustic energy will transmit into the Si substrate, which has larger acoustic impedance, and thus better electromechanical conversion. When the acoustic half wavelength matches the $1 \, \mu m$ AlN thickness, the AlN layer reaches its fundamental resonance mode and becomes more efficient in exciting acoustic waves around 4-4.3 GHz. It is noteworthy that, by optimizing AlN and SiO₂ thicknesses, the resonances of these two cavities can be misaligned to further improve acoustic wave excitation. In addition, the coupling between the Si substrate cavity and the SiO₂ and AlN cavities causes periodic fluctuations of the FSR and higher-order dispersion, as will be discussed later.

The AOM of the microring resonator can be characterized by an optomechanical S_{21} measurement as shown in Fig. 2g. By setting the input laser frequency (~ 1550 nm) at the slope of the optical resonance, the output laser intensity is modulated when a -5 dBm RF signal from port 1 of the vector network analyzer is launched on the AlN. The intensity modulation of the optical signal is measured using a photodiode and sent back to port 2 for the S_{21} measurement. It is noteworthy that no optical and electrical amplifiers are employed to preserve direct electro-opto-mechanical transduction. The optomechanical S₂₁ measurements are performed for both the transverse electric (TE) and transverse magnetic (TM) optical modes, as shown in Fig. 2b, c, respectively. As expected, periodic peaks are observed, which correspond to each HBAR mode in S_{11} . Due to the different optical mode profiles of the TE and TM modes (and thus acousto-optic mode overlaps) and optical Q factors, they respond differently, with the strongest response around 2 GHz for the TE mode and around 4 GHz for the TM mode. As the TE mode shows higher optical Q, it can enter the resolved sideband regime at frequencies beyond its optical linewidth (1-2 GHz), where the modulation sidebands are suppressed when biasing at the resonance slope. The zoom-in of highlighted regions (green shaded areas) are as shown in Fig. 2e, f, illustrating clear peaks with high contrast (>20 dB) between resonance and anti-resonance. Interestingly, the same measurements are performed for devices with a different actuator lateral shape, which show similar results for S₁₁ and S₂₁ of the TE and TM modes (see Supplementary Note 2). This indicates that the HBAR mode distribution and optomechanical spectra are less related to the shape of the actuator, but more to the vertical stack. This relaxes the requirements on actuator shape and size, which lends itself with high design freedom and small footprint.

A numerical Finite Element Method (FEM) simulation of one typical acoustic mode at 2.041 GHz is shown in Fig. 2h and a zoom-in around the optical waveguide is in Fig. 2i. The acoustic standing wave distributes uniformly through the entire substrate, which indicates that the optical circuits can be buried deeply inside the SiO_2 cladding, free from the trade-off between actuation efficiency and absorption losses due to metal as found in traditional optical modulators. Also, due to the orders of magnitude smaller velocity of acoustic waves, the acoustic wavelength at microwave frequencies is comparable to the optical wavelength and waveguide structure. Interestingly, this is



Fig. 2 Microwave frequency electro-acousto-optic modulation. a Electromechanical S₁₁ spectrum from 1 to 5.5 GHz. A range of equidistant bulk acoustic resonances is found to exist over a broad frequency range. The inset schematic illustrates the acoustic wave reflection at interfaces. **b**, **c** Optomechanical S₂₁ responses of TE and TM modes demonstrate acousto-optic modulation covering multiple octave-spanning microwave frequencies. Due to different optical mode shapes (insets in **b** and **c**) and thus acousto-optic mode overlap, TE and TM modes show dissimilar S₂₁ spectra. **d**, **e** The zoom-in of S₁₁ and TE mode's S₂₁ within the window (green shaded area in **b**) around 2 GHz. **f** The zoom-in of TM mode's S₂₁ around 4 GHz in **c**. The resonances distribute evenly with an FSR of 17.5 MHz. **g** Schematic of the setup for measuring electromechanical and optomechanical response. DUT device under test, ECDL external cavity diode laser, FPC fiber polarization controller, PD photo-diode, VNA vector network analyzer. **h** Numerical simulation of vertical stress σ_z distribution for one typical acoustic resonant mode at 2.041 GHz under 1 V driving field, with a zoom-in around the optical waveguide (red box in **h**) shown in **i**. At several GHz, the acoustic wavelength is similar in scale to optical wavelength and waveguide structure. **j** The measured (circle) and calculated (solid line) frequency difference between each pair of adjacent Si resonances, showing a periodic variation of local FSR around an average value of 17.5 MHz. The maxima of FSR align with the SiO₂ resonances marked by green dashed lines. **k** Measured (circle) and calculated (solid line) higher order dispersion represented by the frequency deviation from an equidistant frequency grid (with average FSR = 17.515 MHz), referencing to mode ν_0 (3.0145 GHz). μ is the mode number difference relative to the mode at 3.0145 GHz.

achieved with macroscopic actuators, as the acoustic wavelength is primarily dictated by the material stack and thickness, rather than lithography. Evidently, the simplicity of our structure presents advantages such as simple fabrication, high fabrication tolerance, high rigidity, and high power handling. In addition, it can be seen from Fig. 2h that the acoustic mode is largely confined beneath the actuator which guarantees low electromechanical cross-talk (-60 dB) between adjacent modulators (see Supplementary Note 3). This helps us to place multiple actuators on the same optical ring for compact spatiotemporal modulation as will be discussed in the last section. All these features may supplement the conventional SAW-based AOM for future microwave photonics applications where ultra-high optical Q, low cost, and dense integration are required.

Mechanical mode dispersion. An analytical electromechanical model is established to help us get deep understanding of the mechanical performance of the device (see Supplementary Note 1). As mentioned above, the coupling from SiO₂ and AlN cavities not only modulates the resonances' magnitude envelope but also the dispersion of mechanical modes (deviation from equidistant spectrum). Figure 2j clearly shows the variation of frequency difference (local FSR) between each pair of adjacent resonances. The local FSR varies nearly periodically around an average value of 17.5 MHz with the same period as the envelope in Fig. 2a. By comparing Fig. 2a, j, it can be found that at each node of the envelope, the FSR reaches maximum value, which means the spacing of Si resonances increases near the SiO₂

resonance. From the standpoint of the Si cavity, the variation of FSR can be understood intuitively from the fact that, the wave reflected back into the Si substrate from the Si-SiO₂ interface experiences a varying phase shift at different frequencies. For example, around the SiO₂ resonance, the Si-SiO₂ interface locates at the node of an acoustic stress wave with near-zero stress (maximum displacement), which presents a free boundary condition. Far beyond the SiO₂ resonances, the interface is at an anti-node corresponding to fixed boundary condition (zero displacement). These various boundary conditions each impose a different phase for a given reflected wave and thus change the effective cavity length of Si.

However, for the AlN and SiO₂ cavities, the green dashed lines that denote the location of each SiO₂ resonance lie closely together around 4 GHz where the AlN cavity resonance is located. Also, it can be seen that the average FSR of the acoustic modes decreases around the AlN resonance. Based on these observations and the fact that the acoustic impedance of SiO₂ is smaller than Si and then AlN, we can conclude that, for two coupled acoustic cavities, the small cavity (e.g., SiO₂) with smaller acoustic impedance tends to decrease (increase) the effective cavity length (FSR) of the big cavity (e.g., Si) when it's on resonance compared with off-resonance and vice versa³⁸. This is similar to coupled optical cavities by treating acoustic impedance as the effective refractive index³⁹.

The higher order dispersion is presented in Fig. 2k, which shows the frequency deviation of each resonance from the ideally even distribution grid with reference to mode at 3.0145 GHz and

period of 17.515 MHz. Mathematically, it can be interpreted as the integral of Fig. 2j (i.e., the accumulation of FSR deviation relative to 17.515 MHz) with respect to the origin at 3.0145 GHz. The higher order dispersion also shows periodic variation caused by the coupling between the Si and SiO₂ cavities, which varies between normal and anomalous group velocity dispersion. The roll-off starting around 3.5 GHz is caused by reduced FSR due to coupling of the AlN cavity. This study of mechanical dispersion could benefit the growing field of mechanical dispersion engineering for future applications (e.g., mechanical dissipative solitons^{40,41}, HBAR-based quantum random access memory^{39,42}) and future devices improvement by optimizing Si, SiO₂, and AlN thicknesses or by choosing materials with different acoustic impedance. In this sense, further theoretical and numerical studies are necessary for a more complete understanding of the acoustic wave propagation and mechanical cavity coupling in such a platform.

Ultra-fast stress-optical actuation. Besides the resonant microwave frequency AOM, the proposed stress-optical platform is capable of ultra-fast tuning of optical resonances with ultra-low power consumption. Here, the actuation speed is fully explored, showing sub-ns response time. To do this, the time domain dynamic response is recorded while applying a modulated signal. A small-signal ($V_{pp} = 2 \text{ V}$) square wave (1 MHz) is first applied in Fig. 3a and the transmitted light intensity modulation is measured. Although with only 0.4 pm relative resonant wavelength shifting, the output signal shows clear separation between the two switching states, which is larger than the noise level. This makes it possible for feedback control of Kerr microcombs based on small error signals. We also observe sharp peaks at tuning edges when rapidly switching from one state to the other, which is caused by the excitation of acoustic resonances. These resonances can be damped by roughing the backside surface of the substrate for modulation with wider bandwidth (see Supplementary Note 4).

Periodic (5 MHz) short pulses with 20 ns pulse width are also applied as seen in Fig. 3b. The response follows in good shape with the rising and falling edges with the input pulse. To quantitatively show the similarity between input and output signals, the normalized cross-correlation between them is calculated as shown in the inset of 3b. Indeed, the similarity between the auto-correlation (red) of the input signal itself and the cross-correlation (black) demonstrates ultra-fast actuation beyond the nanosecond.

Despite the high actuation speed, the existence of HBAR modes prevents digital modulation at repetition rates beyond 1 GHz, where a flat and broadband response is usually required as in traditional optical communication. In this sense, preconditioning of the input signal or data post-processing is necessary to eliminate the distortion from mechanical resonances. However, due to the constant $f \cdot Q$ product in a general mechanical resonant systems, the acoustic resonances at high frequency gradually disappear due to the low mechanical Q. If we apply an ultra-high repetition rate (f_{rep}) signal in the mechanical resonance damping-out region, we can get rid of the mechanical resonance induced signal distortion, in an attempt to find the ultimate speed limit of the actuator itself. This is demonstrated in Fig. 3c, where a 6 GHz square wave (gray curve) is applied using a programmable pattern generator and amplified by an optical modulator driver to V_{pp} of 7 V (21 dBm in power). The output optical modulation (orange) shows distinguishable oscillation at the same repetition rate, which suggests that the piezoelectric actuator itself can perform an ultra-fast actuation, despite the fact that broadband modulation is mostly limited by acoustic resonances. Because of the lower responsivity to higher harmonic Fourier components (e.g., 12 GHz, 24 GHz) of the input square wave, the output behaves more like a 6 GHz sinusoidal wave. It is noteworthy that the measured 8 mV V_{pp} corresponds to -38 dBm in power, which suggests an efficiency of -59 dB from RF modulator input to RF output at the photodetector. This modulation efficiency is still far away from the state of the art of electro-optical modulation⁴³. Further measures are currently underway to improve the efficiency such as shrinking the device size and releasing the oxide membrane for better confinement of acoustic energy.

Silicon Nitride optical isolator. The demonstrated time modulation, together with tight spacial localization, enables compact spatiotemporal modulation for studying topological photonics. As a demonstration, we realized, for the first time, an optical isolator built on Si_3N_4 integrated photonics using angular momentum biasing⁴⁴. Optical nonreciprocal devices, such as circulators and isolators, are key building blocks in applications such as signal routing in telecommunication, reflection rejection in high-power lasers, and noise rejection in optical interfaces with



Fig. 3 High-speed temporal modulation. a Time domain response (orange) to a small-signal square wave (gray) with 2 V V_{ppr} 1 MHz repetition rate, and a 50% duty cycle. The sharp peaks at tuning edges are caused by mechanical ringing of acoustic resonances. **b** Time domain response to short pulses with 20 V V_{ppr} , 5 MHz repetition rate, and a 20 ns pulse width, demonstrating ultra-fast (sub-ns) tuning speed. The inset shows the normalized cross-correlation (black) between input and output signals and the auto-correlation (red) of the input signal. The right Y axis in **a**, **b** denotes the resonant wavelength shifting relative to 0 V voltage, according to a measured linear tuning of -0.2 pm V^{-1} . **c** Response to a 6 GHz square wave driving at the frequency where mechanical resonances disappear due to the low mechanical Q. The electrical input signal (gray) is measured by an oscilloscope after 20 dB attenuation of the original signal. The optical output (orange) shows clear oscillations with a frequency equal to the driving field, illustrating GHz level piezoelectric actuation.

superconducting qubits. Conventionally, these blocks are realized using the Faraday effect of magneto-optical materials under magnetic field⁴⁵, which are challenging to integrate on photonic integrated circuits (PICs) and not compatible with super-conducting circuits.

Recently, several magnet-free methods have been employed to demonstrate nonreciprocity on chip by breaking the time-reversal symmetry using optical⁴⁶ or optomechanical⁴⁷ nonlinearities, and stimulated Brillouin scattering48,49, which rely on additional high-power pump laser. It has been theoretically proposed to achieve optical nonreciprocity by momentum biasing through spatiotemporal modulation¹⁵, which can be purely electrically driven and independent of the input laser power. Experimentally, this concept has been demonstrated with integrated AlN photonics using SAW modulation⁵⁰ for linear momentum biasing. However, the isolation is limited by the maximum applicable RF power to the fragile sub-micron electrode fingers. Here, using our HBAR platform we realize angular momentum biasing instead⁴⁴, by placing multiple modulators within a single optical microring resonator to create a circulating refractive index modulation. This scheme benefits from significantly higher power handling capabilities of AlN actuators and thereby improves the attainable isolation.

The nonreciprocity in our device is induced by the direction dependent coupling between two optical modes (*a* and *b*) of a ring by the dynamic modulation¹⁵. To couple the two optical modes efficiently, both energy and momentum conservation need to be satisfied as shown in the ω -k space in Fig. 4a. This can be

achieved by driving a rotational modulation wave along the ring whose frequency equals the frequency difference of the two optical modes. Meanwhile, the modulation wave carries a positive momentum Δk in the counter-clockwise (CCW) direction. Thus, the light in the ring can only be scattered in ω -k space along the vector that is predefined by the spatiotemporal modulation. Taking mode *a* for example, in the forward direction (positive *k*), light injected in mode *a* will be scattered into mode *b*, which can also be scattered back. For sufficiently strong driving, where the rate of energy exchange between the two optical modes exceeds their loss rates, there will be Rabi mode splitting and transparency at resonance¹⁵ (Fig. 4b). This can be understood qualitatively as the result of interference of the light that is directly coupled from the bus waveguide and the one that is first converted to the mode b and then converted back. At resonance, the phase difference between the two optical paths is π and thus destructively interfere. For the light in the bus, it will transmit without seeing the ring. On the other hand, if the light is in the backward direction and thus clockwise (CW) (negative k) in the ring, the scattering between the two modes is forbidden due to momentum mismatch. The ring will then show the original resonance dip and absorb all the light at critical coupling. Similar results can be obtained when we probe mode b.

Figure 4c shows the image of the fabricated device. Fundamental TE and TM polarization modes are chosen, as they can be easily engineered to have close frequencies and controlled experimentally using polarization controller. The spacing between a pair of TE and TM modes is found by measuring the optical



Fig. 4 Si₃N₄ optical isolator via spatiotemporal modulation. a Schematic showing directionally dependent coupling between two optical modes *a* and *b* in ω -*k* space, induced by a rotating modulation wave. **b** In the forward direction, light transmits at resonance due to mode splitting from the strong coupling between modes *a* and *b*. Light in the backwards direction, however, will be absorbed due to phase mismatch and inefficient mode coupling. **c** Simplified schematics of measurement setup. The inset is the optical microscopy image of the fabricated device. Three AIN piezoelectric actuators are driven with fixed phase differences, generating a synthetic circulating wave along the ring. FPCs control the polarization of input and output light, and the polarization beam splitter (PBS) filters out unwanted modulation sidebands. **d** Optical transmission showing one pair of TE and TM resonant modes that are closely spaced by only 3.36 GHz. **e** Optical transmission of TE mode in forward and backward directions (with respect to off-chip input laser of -3 dBm) under +36 dBm RF driving. A 17 dB isolation is achieved at resonance with a bandwidth of 1 GHz.

transmission as inputting a mixture of TE and TM polarization light (Fig. 4d), where 3.36 GHz is obtained. One of the HBAR modes around the spacing frequency is excited to temporally modulate the ring. The clear separation ensures to work at resolved sideband regime where the modulation frequency is larger than the optical linewidth. Also, since the optical FSR is 200 GHz and the waveguide is designed to only support fundamental TE and TM mode families, the other undesired modes are far away from the two closely spaced TE and TM modes. Therefore, most energy scattering will be between the two modes of interest, and the probability of scattering to undesirable modes is low. The spatially varying modulation, required for momentum conservation, is realized by placing three discrete actuators that are equally spaced along the ring. By driving them with fixed phase differences (0°, 120°, 240°), an effective rotational wave is formed circulating around the ring, which induces coupling between the two optical modes only in CCW direction. More details about the effect of discrete modulation regions and sensitivity to RF relative phases can be found in the Supplementary Note 5.

In measuring the nonreciprocity, the polarization of input light is aligned to couple to TE mode only, and the output converted TM light is filtered with only TE light measured. Under +36 dBm RF driving power on each actuator, 17 dB isolation contrast at resonance between two directions is achieved as shown in Fig. 4e. The isolation bandwidth of 1 GHz is mainly limited by the linewidth of the optical TE resonance. The maximum transmission in forward direction is around -10 dB. It is noteworthy that this is the off-chip insertion loss, which includes -4 dB loss per fiber to chip coupling facet, and fiber and connectors losses. As the on-chip waveguide loss is -0.1 dB mm^{-1} , the on-chip insertion loss is around -0.5 dB under 5 mm chip length. The high RF power can be further reduced in the future by increasing the optical Q using optimized photonic Damascene process⁵¹ (~8 dBm is enough for 5 million Q, corresponding to $1.6 \text{ V} V_{pp}$, which is CMOS compatible). By cascading the device into multiple coupled rings, our platform enables to investigate experimentally new physical phenomena, such as synthetic dimensions¹⁶ and Floquet dynamics in topological photonics¹⁷, which rely on modulation in both time and space domain.

Discussion

In conclusion, we demonstrate the integration of HBAR resonators within a nanophotonic platform. We realize a hybrid multifunctional stress-optical platform based on bulk acoustic waves. In the device, acoustic resonances are effectively generated by a macroscopic AlN actuator, and are used for microwave frequency AOM. These acoustic modes are evenly distributed over a broad frequency range up to 6 GHz. As an application, we realize an optical isolator in Si₃N₄ PICs platform using spatiotemporal modulation of the ring resonator via localized HBAR modes. This could serve not only as an important building block in Si₃N₄ photonics, but may also open up new pathways to investigate novel topological photonics. The same platform could also be engineered for quantum microwave to optical conversion³⁹, which together with the isolator could act as an optical interface for superconducting circuits with high quantum efficiency and low noise cross-talk between the optical and microwave domain. Altogether, these advantages serve to produce a device which is not only novel, but has the potential for widespread applications across a variety of fields.

Methods

Device fabrication. The Si₃N₄ waveguides are fabricated using a subtractive process³⁷. The fabrication process of AlN piezoelectric actuators is described here in detail. 100 nm Mo and 1 µm polycrystalline AlN films are sputtered on SiO₂

cladding through foundry services (OEM Group). The AlN disk is patterned by AZ1518 photoresist and dry-etched using Cl_2 and BCl_3 in a Panasonic E620 Etcher. The dry etching of the bottom electrode (Mo) is performed using Cl_2 in the same Panasonic E620 Etcher. Finally, the top 100 nm of Al is evaporated by a PVD E-beam evaporator and patterned using a standard lift-off process. The whole wafer is diced into individual chips by deep reactive ion etching (DRIE) followed by mechanical polishing of the Si substrate. This enables smooth chip facets for efficient coupling of light from lensed fiber to inverse waveguide taper at the edge. This three-mask, photolithographic-only fabrication leads to a low cost and high fabrication tolerance. Mechanical Q can be further increased in the future by conducting Chemical Mechanical Polishing (CMP) instead of mechanical polishing, which will produce sub-nanometer surface roughness.

Experimental setup. The electromechanical S₁₁ reflection response is measured by port 1 of a network analyzer (Agilent E8364B), where the electrical signal is applied to the device through an RF GS probe (GGB 40A-GS-150). For the optomechanical S21 measurment, around 100 μ W continuous wave light from a diode laser (Velocity Tunable Laser 6328) is edge-coupled to the device using a lensed fiber via inverse taper. A -5 dBm RF electrical signal is applied from port 1 of the network analyzer to drive the piezoelectric actuator and the light intensity modulation is detected by a 12 GHz photodiode (New Focus 1544), which is sent back to port 2 of the network analyzer.

In the high repetition rate time domain modulation measurement, a 6 GHz square wave is supplied by a programmable pattern generator (Tektronix PPG1251), which is amplified by an optical modulator driver (WJ communication SA1137-2) to 7 V $V_{\rm pp}$ before applying to the device. The intensity modulation is detected by the same photodiode (New Focus 1544) and then recorded by a broad bandwidth oscilloscope (Tektronix DSA8200).

Data availability

All relevant data are available from the authors upon reasonable request.

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References

- Moss, D. J., Morandotti, R., Gaeta, A. L. & Lipson, M. New cmos-compatible platforms based on silicon nitride and hydex for nonlinear optics. *Nat. Photonics* 7, 597–607 (2013).
- Gyger, F. et al. Observation of stimulated Brillouin scattering in silicon nitride integrated waveguides. *Phys. Rev. Lett.* **124**, 013902 (2020).
- Gaeta, A. L., Lipson, M. & Kippenberg, T. J. Photonic-chip-based frequency combs. Nat. Photonics 13, 158–169 (2019).
- Kippenberg, T. J., Holzwarth, R. & Diddams, S. A. Microresonator-based optical frequency combs. *Science* 332, 555–559 (2011).
- Huffman, T. A. et al. Integrated resonators in an ultralow loss si 3 n 4/sio 2 platform for multifunction applications. *IEEE J. Sel. Top. Quantum Electron.* 24, 1–9 (2018).
- Gundavarapu, S. et al. Interferometric optical gyroscope based on an integrated si 3 n 4 low-loss waveguide coil. J. Lightwave Technol. 36, 1185–1191 (2018).
- 7. Pfeifle, J. et al. Coherent terabit communications with microresonator kerr frequency combs. *Nat. Photonics* **8**, 375 (2014).
- Li, Q. et al. Stably accessing octave-spanning microresonator frequency combs in the soliton regime. *Optica* 4, 193–203 (2017).
- Pfeiffer, M. H. P. et al. Octave-spanning dissipative kerr soliton frequency combs in si3n4 microresonators. *Optica* 4, 684–691 (2017).
- Liu, J. et al. Ultralow-power chip-based soliton microcombs for photonic integration. Optica 5, 1347–1353 (2018).
- 11. Stern, B., Ji, X., Okawachi, Y., Gaeta, A. L. & Lipson, M. Battery-operated integrated frequency comb generator. *Nature* **562**, 401–405 (2018).
- Raja, A. S. et al. Electrically pumped photonic integrated soliton microcomb. Nat. Commun. 10, 680 (2019).
- Liu, J. et al. Photonic microwave generation in the x-and k-band using integrated soliton microcombs. *Nat. Photonics* 1–6 (2020).
- Spencer, D. T. et al. An optical-frequency synthesizer using integrated photonics. *Nature* 557, 81–85 (2018).
- Shi, Y., Lin, Q., Minkov, M. & Fan, S. Nonreciprocal optical dissipation based on direction-dependent rabi splitting. *IEEE J. Sel. Top. Quantum Electron.* 24, 1–7 (2018).
- Yuan, L., Lin, Q., Xiao, M. & Fan, S. Synthetic dimension in photonics. *Optica* 5, 1396–1405 (2018).
- Rechtsman, M. C. et al. Photonic floquet topological insulators. *Nature* 496, 196 (2013).

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- Xue, X. et al. Thermal tuning of kerr frequency combs in silicon nitride microring resonators. *Opt. Express* 24, 687–698 (2016).
- Joshi, C. et al. Thermally controlled comb generation and soliton modelocking in microresonators. *Opt. Lett.* 41, 2565–2568 (2016).
- Moille, G. et al. Kerr-microresonator soliton frequency combs at cryogenic temperatures. *Phys. Rev. Appl.* 12, 034057 (2019).
- 21. Yao, B. et al. Gate-tunable frequency combs in graphene-nitride microresonators. *Nature* **558**, 410 (2018).
- 22. Alexander, K. et al. Nanophotonic pockels modulators on a silicon nitride platform. *Nat. Commun.* 9, 3444 (2018).
- Ahmed, A. N. R., Shi, S., Zablocki, M., Yao, P. & Prather, D. W. Tunable hybrid silicon nitride and thin-film lithium niobate electro-optic microresonator. *Opt. Lett.* 44, 618–621 (2019).
- 24. Datta, I. et al. Low-loss composite photonic platform based on 2d semiconductor monolayers. *Nat. Photonics* 14, 256–262 (2020).
- Huang, M. Stress effects on the performance of optical waveguides. Int. J. Solids Struct. 40, 1615–1632 (2003).
- Van Der Slot, P. J., Porcel, M. A. & Boller, K.-J. Surface acoustic waves for acousto-optic modulation in buried silicon nitride waveguides. *Opt. Express* 27, 1433–1452 (2019).
- 27. Hosseini, N. et al. Stress-optic modulator in triplex platform using a piezoelectric lead zirconate titanate (pzt) thin film. *Opt. Express* 23, 14018–14026 (2015).
- Jin, W., Polcawich, R. G., Morton, P. A. & Bowers, J. E. Piezoelectrically tuned silicon nitride ring resonator. *Opt. Express* 26, 3174–3187 (2018).
- Midolo, L., Schliesser, A. & Fiore, A. Nano-opto-electro-mechanical systems. Nat. Nanotechnol. 13, 11 (2018).
- MacQuarrie, E., Gosavi, T., Jungwirth, N., Bhave, S. & Fuchs, G. Mechanical spin control of nitrogen-vacancy centers in diamond. *Phys. Rev. Lett.* 111, 227602 (2013).
- Tadesse, S. A. & Li, M. Sub-optical wavelength acoustic wave modulation of integrated photonic resonators at microwave frequencies. *Nat. Commun.* 5, 5402 (2014).
- Marpaung, D., Yao, J. & Capmany, J. Integrated microwave photonics. Nat. Photonics 13, 80 (2019).
- Obrzud, E., Lecomte, S. & Herr, T. Temporal solitons in microresonators driven by optical pulses. *Nat. Photonics* 11, 600 (2017).
- Fan, L., Zou, C.-L., Zhu, N., Tang, H. X. Spectrotemporal shaping of itinerant photons via distributed nanomechanics. *Nat. Photonics* 13, 323–327 (2019).
- Supradeepa, V. et al. Comb-based radiofrequency photonic filters with rapid tunability and high selectivity. *Nat. Photonics* 6, 186 (2012).
- Tsubouchi, K. & Mikoshiba, N. Zero-temperature-coefficient saw devices on aln epitaxial films. *IEEE Trans. Sonics Ultrason.* 32, 634–644 (1985).
- Luke, K., Dutt, A., Poitras, C. B. & Lipson, M. Overcoming si3n4 film stress limitations for high quality factor ring resonators. *Opt. Express* 21, 22829–22833 (2013).
- Zhang, Y., Wang, Z. & Cheeke, J. D. N. Resonant spectrum method to characterize piezoelectric films in composite resonators. *IEEE Trans. Ultrason. Ferroelectr. Frequency Control* 50, 321–333 (2003).
- 39. Kharel, P. et al. High-frequency cavity optomechanics using bulk acoustic phonons. *Sci. Adv.* **5**, eaav0582 (2019).
- Herr, T. et al. Temporal solitons in optical microresonators. Nat. Photonics 8, 145 (2014).
- 41. Goryachev, M., Galliou, S. & Tobar, M. E. Generation of ultralow power phononic combs. *Phys. Rev. Res.* 2, 023035 (2020).
- Hann, C. T. et al. Hardware-efficient quantum random access memory with hybrid quantum acoustic systems. *Phys. Rev. Lett.* **123**, 250501 (2019).
- Wang, C. et al. Integrated lithium niobate electro-optic modulators operating at cmos-compatible voltages. *Nature* 562, 101–104 (2018).
- Sounas, D. L. & Alu, A. Angular-momentum-biased nanorings to realize magnetic-free integrated optical isolation. ACS Photonics 1, 198–204 (2014).
- Huang, D. et al. Dynamically reconfigurable integrated optical circulators. Optica 4, 23–30 (2017).
- DelBino, L. et al. Microresonator isolators and circulators based on the intrinsic nonreciprocity of the kerr effect. *Optica* 5, 279–282 (2018).
- Ruesink, F., Miri, M.-A., Alu, A. & Verhagen, E. Nonreciprocity and magnetic-free isolation based on optomechanical interactions. *Nat. Commun.* 7, 13662 (2016).

- Dong, C.-H. et al. Brillouin-scattering-induced transparency and nonreciprocal light storage. Nat. Commun. 6, 1–6 (2015).
- Kim, J., Kuzyk, M. C., Han, K., Wang, H. & Bahl, G. Non-reciprocal brillouin scattering induced transparency. *Nat. Phys.* 11, 275–280 (2015).
- Sohn, D. B., Kim, S. & Bahl, G. Time-reversal symmetry breaking with acoustic pumping of nanophotonic circuits. *Nat. Photonics* 12, 91 (2018).
- Pfeiffer, M. H. et al. Ultra-smooth silicon nitride waveguides based on the damascene reflow process: fabrication and loss origins. *Optica* 5, 884–892 (2018).

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Author contributions

B.D. and M.Z. designed and fabricated the Si₃N₄ microring ring resonator and AlN actuators, supervised by T.J.K. and S.A.B. J.L. and M.Z. developed Si₃N₄ fabrication processes. H.T. conducted the electromechanical S₁₁ and optomechanical S₂₁ measurements, developed electromechanical model, characterized the time domain response, and developed post-process for removing acoustic resonance. The project was initiated by T.J. K. and S.A.B. All authors discussed the data and simulations. The manuscript was written by H.T., J.L., J.C.S., T.J.K., and S.A.B.

Competing interests

The authors declare no competing interests.

Additional information

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